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## **ON Semiconductor**®

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### Features

- Maximum Junction Temperature : T<sub>J</sub> = 175<sup>o</sup>C
- Positive Temperature Co-efficient for Easy Parallel Operating
- High Current Capability
- Low Saturation Voltage:  $V_{CE(sat)}$  = 1.6 V(Typ.) @ I<sub>C</sub> = 40 A
- + 100% of the Parts Tested for  $I_{LM}(1)$
- · High Input Impedance
- · Fast Switching
- Tighten Parameter Distribution
- · RoHS Compliant

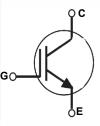
### **General Description**

Using novel field stop IGBT technology, Fairchild's new series of field stop 3<sup>rd</sup> generation IGBTs offer the optimum performance for solar inverter, UPS, welder, telecom, ESS and PFC applications where low conduction and switching losses are essential.

### Applications

• Solar Inverter, UPS, Welder, Telecom, ESS, PFC





### Absolute Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Description		FGH40T65SH	Unit	
V <sub>CES</sub>	Collector to Emitter Voltage		650	V	
V <sub>GES</sub>	Gate to Emitter Voltage		± 20	V	
• GES	Transient Gate to Emitter Voltage		± 30	V	
Ic	Collector Current	@ T <sub>C</sub> = 25°C	80	А	
iC .	Collector Current	@ T <sub>C</sub> = 100 <sup>o</sup> C	40	A	
I <sub>LM (1)</sub>	Pulsed Collector Current	@ T <sub>C</sub> = 25°C	120	А	
I <sub>CM (2)</sub>	Pulsed Collector Current		120	А	
P <sub>D</sub>	Maximum Power Dissipation	@ T <sub>C</sub> = 25°C	268	W	
U U	Maximum Power Dissipation	@ T <sub>C</sub> = 100°C	134	W	
TJ	Operating Junction Temperature		-55 to +175	°C	
T <sub>stg</sub>	Storage Temperature Range		-55 to +175	°C	
TL	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 seconds		300	°C	

#### Notes:

1.  $V_{CC}$  = 400 V,  $V_{GE}$  = 15 V, I\_C =120 A, R\_G = 41.6  $\Omega,$  Inductive Load

2. Repetitive rating: Pulse width limited by max. junction temperature

June 2015

Therma	I Char	acteristics								
Symbo	ol	Parameter			FGH40T65SH					Unit
$R_{ ext{ heta}JC}$	The	Thermal Resistance, Junction to Case, Max.			0.56				°C/W	
R <sub>θJA</sub>	The	Thermal Resistance, Junction to Ambient, Max.			40				°C/W	
Package	e Mark	ing and Orderi	ng Ir	form	ation					
Part Nu	mber	Top Mark	Pac	kage	Packing Met	thod	Reel Size	Tape W	idth C	uantity
FGH40T65	SH_F155	FGH40T65SH	TO-24	7 G03	Tube		-	-		30
Electric	al Cha	racteristics of	the l	GBT	T <sub>C</sub> = 25°C unless othe	erwise no	oted			
Symbol		Parameter	_		Test Conditio	ons	Min.	Тур.	Max.	Unit
Off Charac	teristics									
BV <sub>CES</sub>	Collector	to Emitter Breakdown	/oltage	V <sub>GE</sub> =	0V, I <sub>C</sub> = 1 mA		650	-	-	V
ΔBV <sub>CES</sub> / ΔT <sub>J</sub>	Tempera Voltage	ture Coefficient of Brea	kdown	I <sub>C</sub> = 1	mA, Reference to	o 25ºC	-	0.6	-	V/°C
I <sub>CES</sub>	Collector	Cut-Off Current	_	V <sub>CE</sub> =	V <sub>CES</sub> , V <sub>GE</sub> = 0 V		-	-	250	μA
I <sub>GES</sub>	G-E Lea	kage Current		V <sub>GE</sub> =	$V_{GES}$ , $V_{CE}$ = 0 V			-	±400	nA
On Charac	teristics			1						
V <sub>GE(th)</sub>	G-E Thre	eshold Voltage	_	$I_{\rm C} = 40$	0 mA, V <sub>CE</sub> = V <sub>GE</sub>		4.0	5.5	7.5	V
- (- /		č		I <sub>C</sub> = 40 A, V <sub>GE</sub> = 15 V		-	1.6	2.1	V	
V <sub>CE(sat)</sub>	Collector to Emitter Saturation Voltage		$I_{\rm C}$ = 40 A, $V_{\rm GE}$ = 15 V, T <sub>C</sub> = 175°C		-	2.14	-	v		
Dynamic C	haracteri	stics								
C <sub>ies</sub>	1	pacitance					-	1995	-	pF
C <sub>oes</sub>	Output C	Dutput Capacitance		V <sub>CE</sub> = 30 V, V <sub>GE</sub> = 0 V,		-	70	-	pF	
C <sub>res</sub>	Reverse	Transfer Capacitance		f = 1MHz		-	23	-	pF	
Switching	Character	ristics		•						1
t <sub>d(on)</sub>	r	Delay Time					-	19.2	-	ns
t <sub>r</sub>	Rise Tim	-					- 1	34.4	- /	ns
t <sub>d(off)</sub>	Turn-Off	Delay Time		V <sub>CC</sub> =	V <sub>CC</sub> = 400 V, I <sub>C</sub> = 40 A, R <sub>G</sub> = 6 Ω, V <sub>GE</sub> = 15 V,			65.6	-	ns
t <sub>f</sub>	Fall Time	9		R <sub>G</sub> = 6			-	9.6	-	ns
E <sub>on</sub>	Turn-On	Switching Loss		Inductive Load, T <sub>C</sub> = 25		ъс	-	1010	-	uJ
E <sub>off</sub>	Turn-Off	Switching Loss					-	297	- /	uJ
E <sub>ts</sub>	Total Sw	itching Loss					-	1307	-	uJ
t <sub>d(on)</sub>	Turn-On	Delay Time					-	18.4	-	ns
t <sub>r</sub>	Rise Tim	e					-	32.8	-	ns
t <sub>d(off)</sub>	Turn-Off	Delay Time		V <sub>CC</sub> = 400 V, I <sub>C</sub> = 40 A,			-	71.2	-	ns
t <sub>f</sub>	Fall Time		R <sub>G</sub> = 6 Ω, V <sub>GE</sub> = 15 V,			-	14.4	-	ns	
Eon	Turn-On	Switching Loss		Inductive Load, T <sub>C</sub> = 175		5°C	-	1390	-	uJ
E <sub>off</sub>	Turn-Off	Switching Loss					-	541	-	uJ
E <sub>ts</sub>	Total Sw	itching Loss		1			-	1931	-	uJ

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**Test Conditions** 

 $V_{CE}$  = 400 V, I<sub>C</sub> = 40 A, V<sub>GE</sub> = 15 V

Min.

-

-

-

Тур.

72.2

13.5

28.5

Max

-

-

-

Unit

nC

nC

nC

### Electrical Characteristics of the IGBT (Continued)

Parameter

Total Gate Charge

Gate to Emitter Charge

Gate to Collector Charge

Symbol

 $\mathsf{Q}_\mathsf{g}$ 

 $\mathsf{Q}_{\mathsf{ge}}$ 

 $\mathsf{Q}_{\mathsf{gc}}$ 

### **Typical Performance Characteristics**

### Figure 1. Typical Output Characteristics

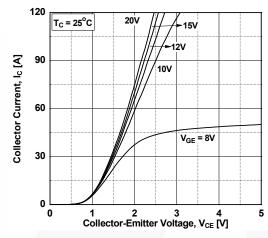


Figure 3. Typical Saturation Voltage Characteristics

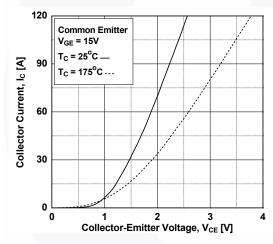


Figure 5. Saturation Voltage vs. V<sub>GE</sub>

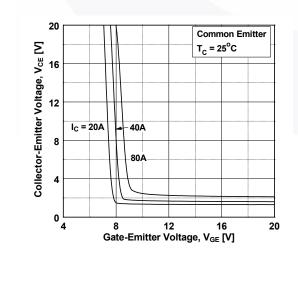
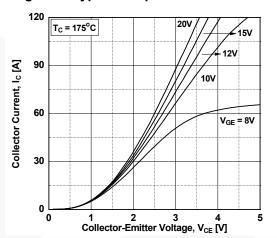


Figure 2. Typical Output Characteristics





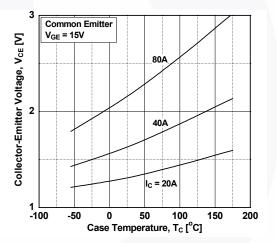
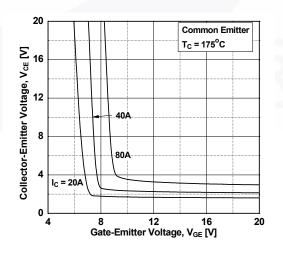


Figure 6. Saturation Voltage vs. V<sub>GE</sub>



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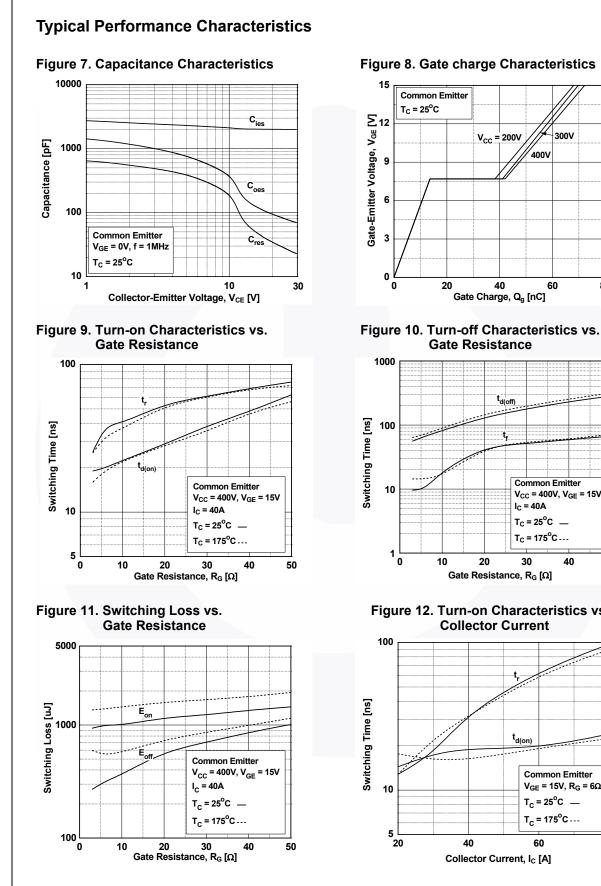


Figure 8. Gate charge Characteristics

V<sub>CC</sub> = 200V

40

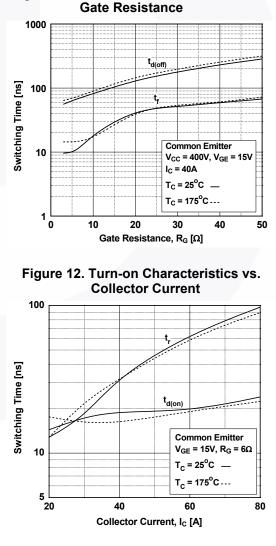
Gate Charge, Qg [nC]

300V

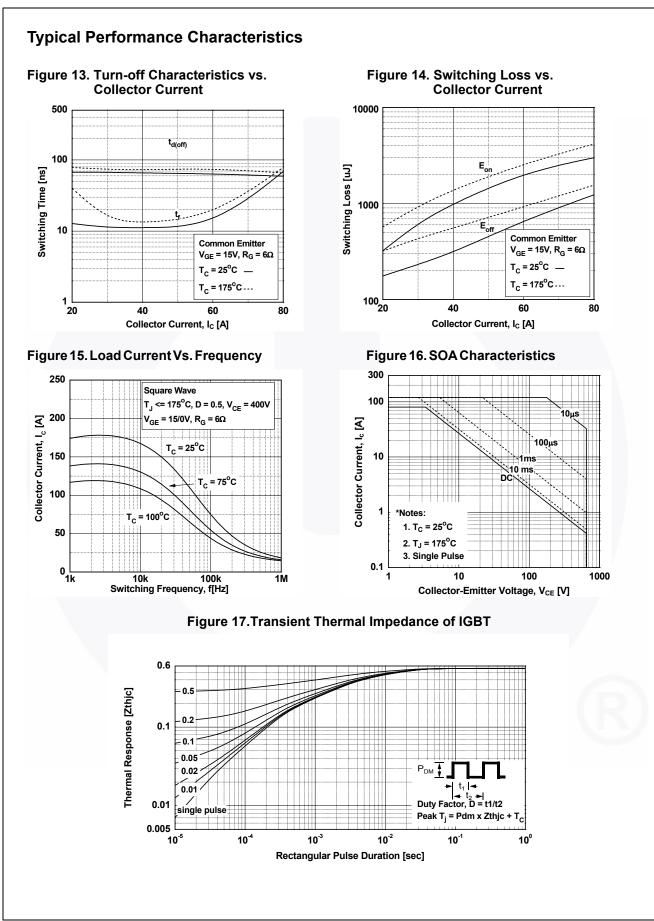
400V

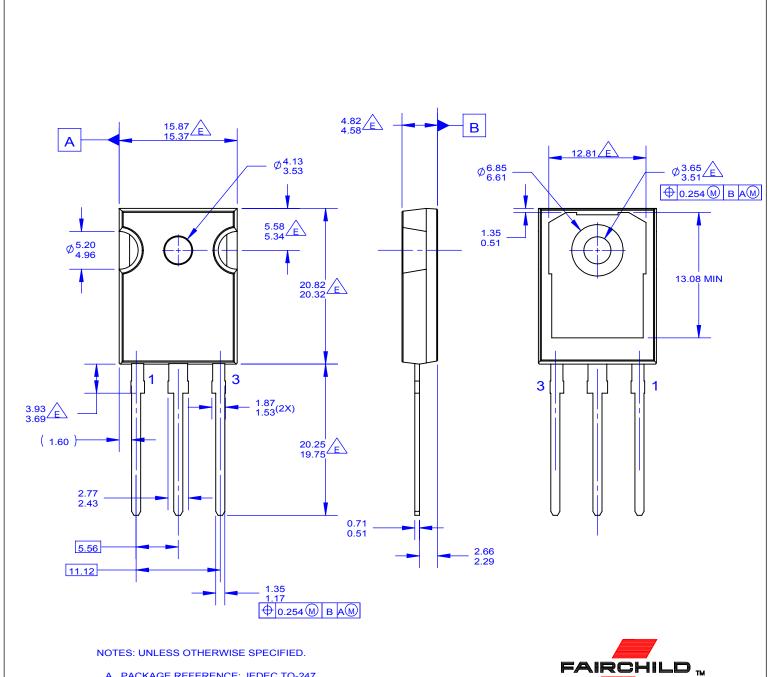
60

80









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